



# GS313C thru GS320C

Surface Mount General Purpose Rectifiers  
Reverse Voltage 1300V to 2000V Forward Current 3A

## Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Construction utilizes void-free molded plastic technique
- For surface mounted applications
- Built-in strain relief, ideal for automated placement
- High temperature soldering guaranteed: 260°C/10 seconds at terminals
- Component in accordance to RoHS 2015/863/EU



DO-214AB (SMC)

## Absolute Maximum Ratings and Electrical Characteristics

(Ratings at 25°C ambient temperature unless otherwise specified, Single phase ,half wave 60Hz, resistive or inductive load. For capacitive load, derated by 20%.)

Parameter	Symbol	GS313C	GS316C	GS318C	GS320C	Unit		
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	1300	1600	1800	2000	V		
Maximum RMS Voltage	$V_{RMS}$	910	1120	1260	1400	V		
Maximum DC Blocking Voltage	$V_{DC}$	1300	1600	1800	2000	V		
Maximum Average Forward Rectified Current	$I_{(AV)}$	3.0				A		
Peak Forward Surge Current (8.3ms Half Sine-wave Superimposed on Rated Load (JEDEC method))	$I_{FSM}$	100				A		
Maximum Instantaneous Forward Voltage at 3.0A	$V_F$	1.15				V		
Maximum Reverse Current at Rated DC Blocking Voltage	$T_A=25^\circ C$	$I_R$	5			uA		
	$T_A=125^\circ C$		100					
Typical Thermal Resistance	$R_{\theta JA}$	40			$^\circ C/W$			
	$R_{\theta JL}$	15						
Junction Temperature	$T_J$	-55 to +150				$^\circ C$		
Storage Temperature	$T_{STG}$	-55 to +150				$^\circ C$		

## Ratings and Characteristic Curves

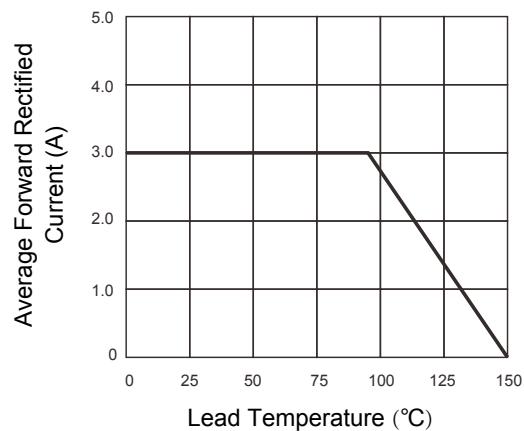


Figure 1. Forward Current Derating Curve

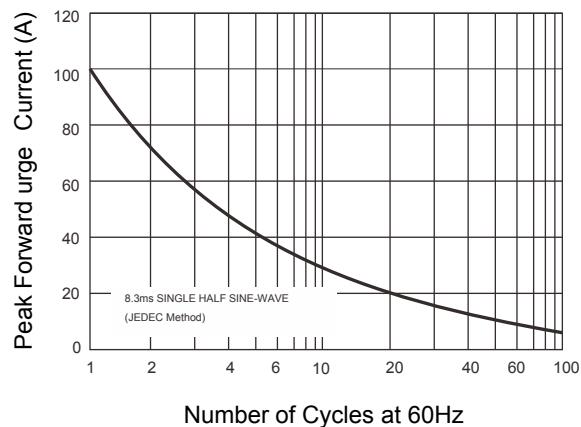


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

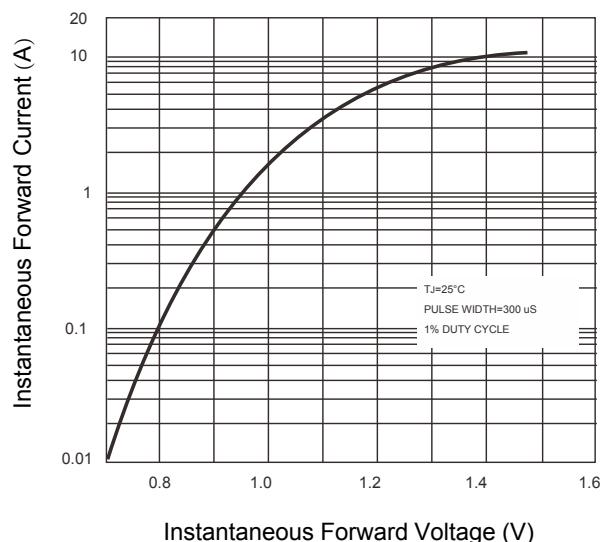


Figure 3. Typical Instantaneous Forward Characteristics

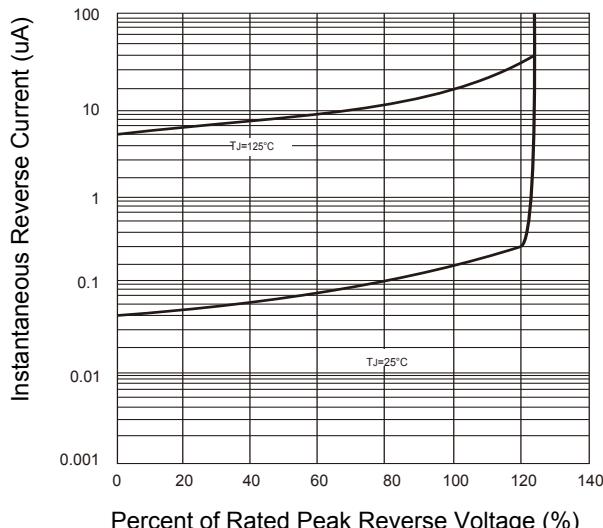


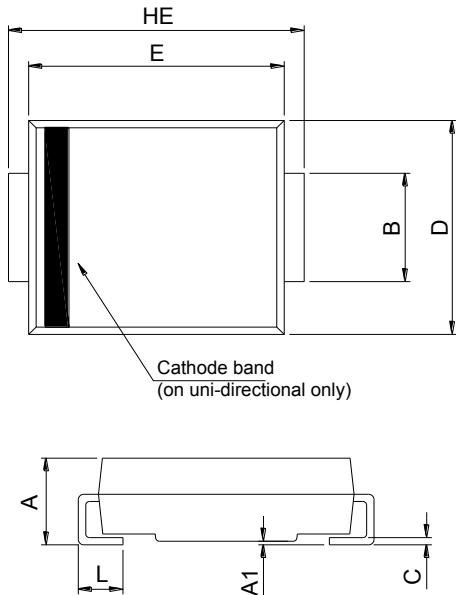
Figure 4. Typical Reverse Leakage Characteristics



# GS313C thru GS320C

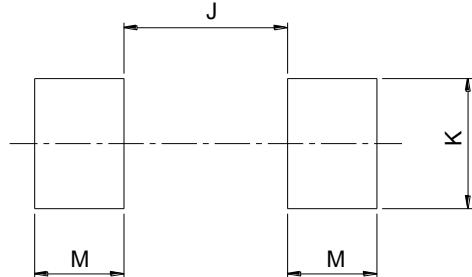
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## Package Outline Dimensions DO-214AB (SMC)



SMC (DO-214AB)				
DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.00	2.62	0.079	0.103
A1	0.00	0.20	0.000	0.008
B	2.75	3.25	0.108	0.128
C	0.15	0.31	0.006	0.012
D	5.58	6.22	0.220	0.245
E	6.60	7.15	0.260	0.281
HE	7.75	8.15	0.305	0.321
L	0.76	1.60	0.030	0.063

## Recommended Pad Layout



SMC Recommended Pad Layout (Reference ONLY)				
DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.
J	-	4.60	-	0.181
K	3.20	-	0.126	-
M	2.00	-	0.079	-

## Order information

Device	Package	Marking	Quantity	HSF Status
GS313C	SMC	S313C	3,000pcs / Reel	RoHS Compliant
GS316C	SMC	S316C	3,000pcs / Reel	RoHS Compliant
GS318C	SMC	S318C	3,000pcs / Reel	RoHS Compliant
GS320C	SMC	S320C	3,000pcs / Reel	RoHS Compliant

For more information, please contact us at: [inquiry@goodarksemi.com](mailto:inquiry@goodarksemi.com)